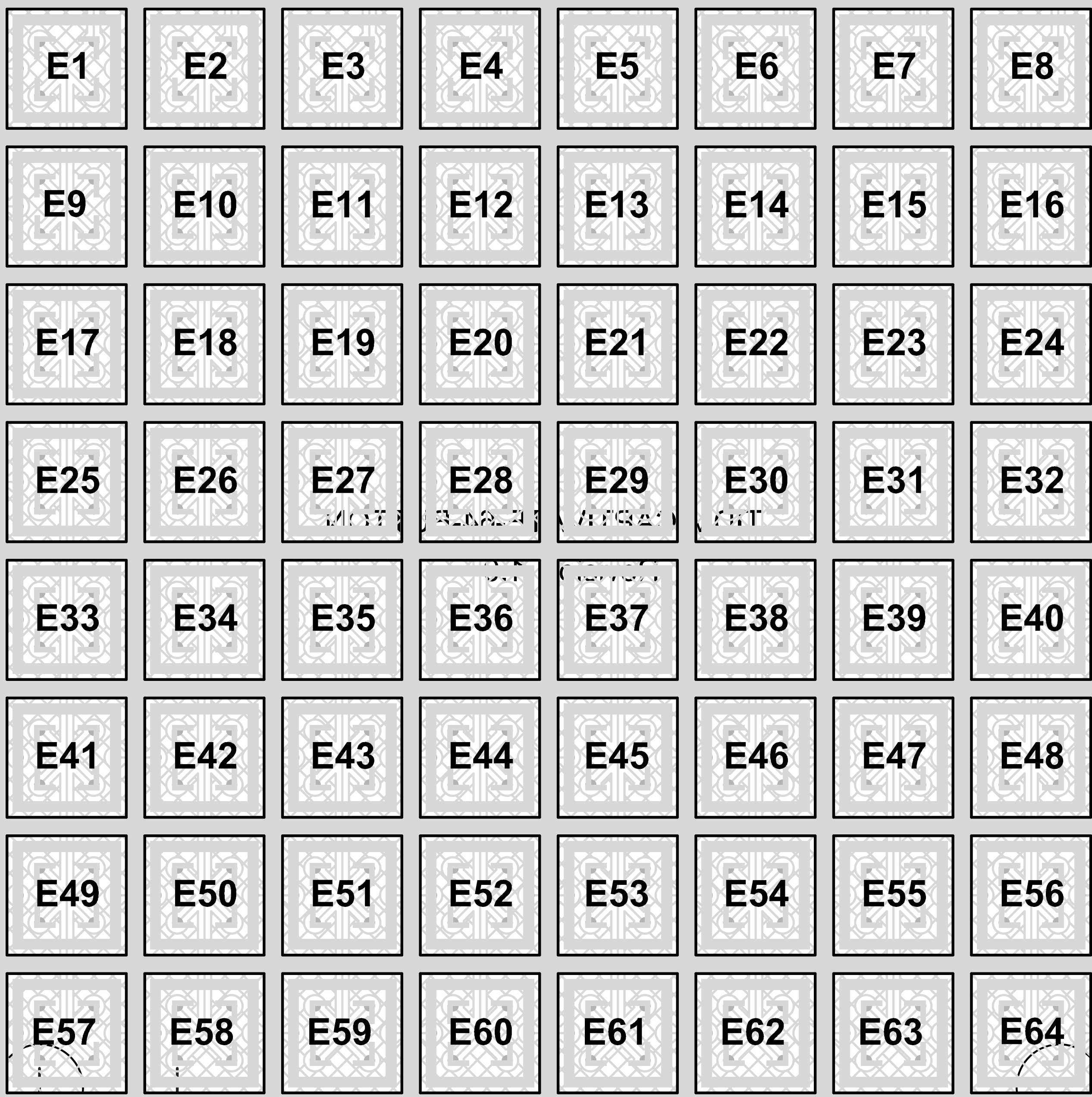
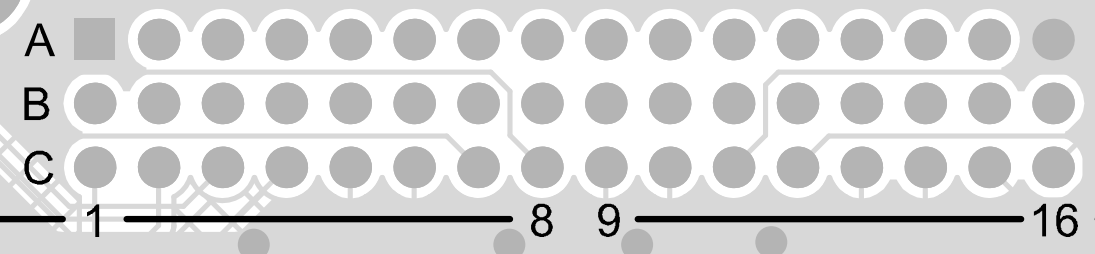


4300.00

PCB Edge



MSP CapTIvate™ MCUs



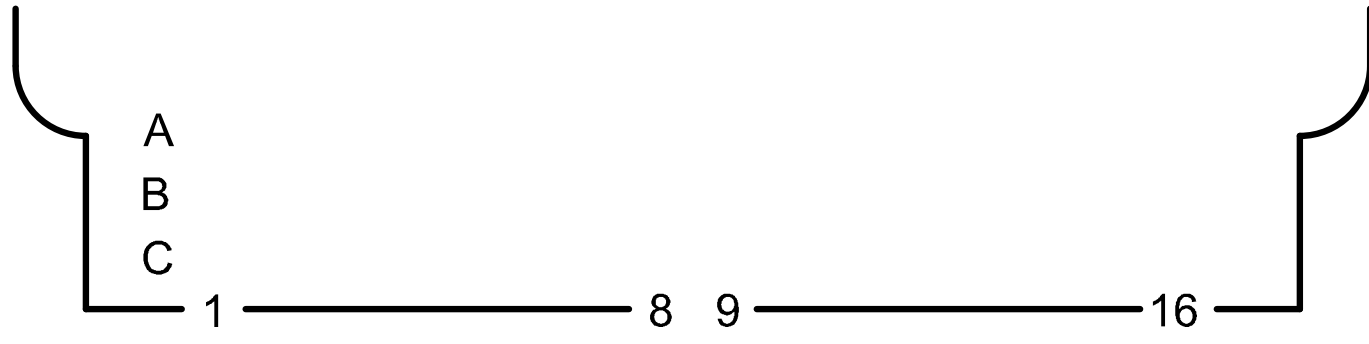
4800.00

500.00

11.00

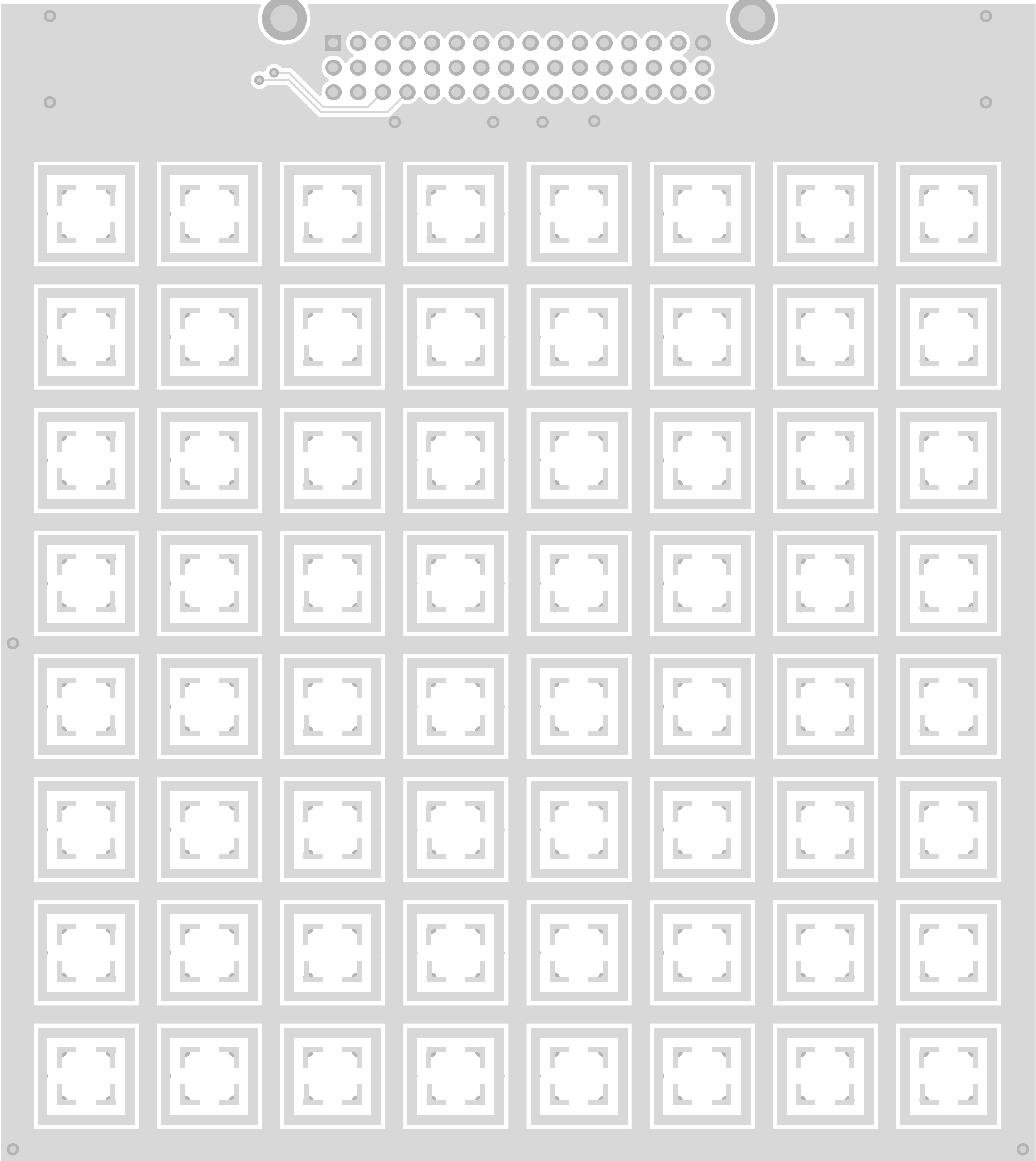


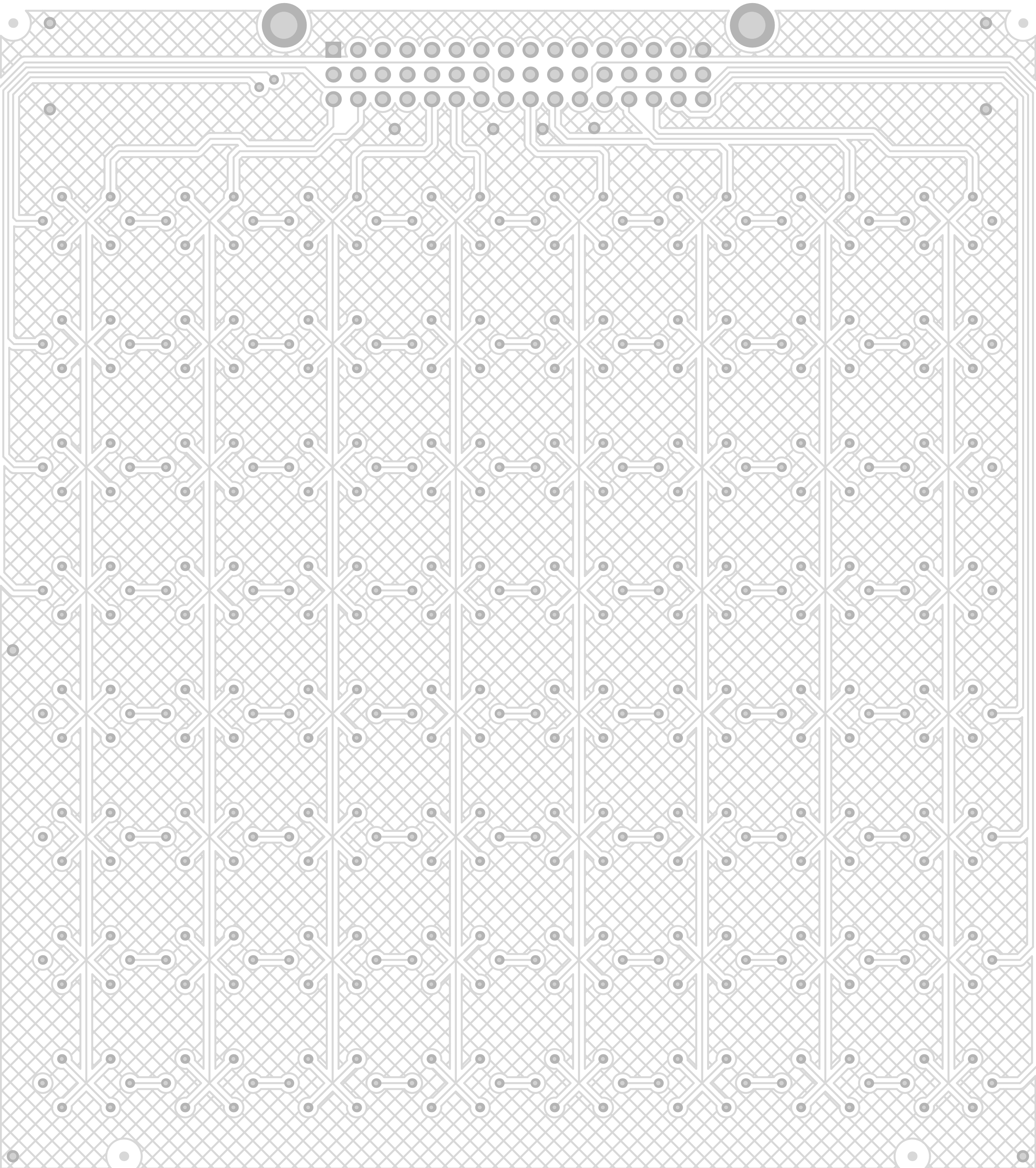
1000.00mil



MSP CapTIvate™ MCUs

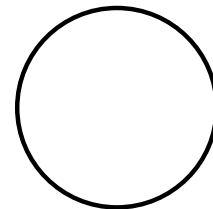
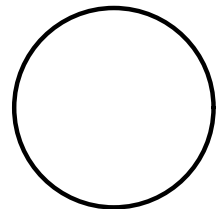
E1	E2	E3	E4	E5	E6	E7	E8
E9	E10	E11	E12	E13	E14	E15	E16
E17	E18	E19	E20	E21	E22	E23	E24
E25	E26	E27	E28	E29	E30	E31	E32
E33	E34	E35	E36	E37	E38	E39	E40
E41	E42	E43	E44	E45	E46	E47	E48
E49	E50	E51	E52	E53	E54	E55	E56
E57	E58	E59	E60	E61	E62	E63	E64





TDM-CAPTIVATE-64-BUTTON  
Revision 1.0

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